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QOCKET NUMBER: 215207US0PCT/pmh

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN E APPLICATION OF:

: GROUP: 1755

COSIII ORIKABE, et al.

: ATTENTION:

SERIAL NUMBER: 09/926,370

Application Division Customer Corrections

FILED: DECEMBER 28, 2001

FOR: THERMOSETTING RESIN COMPOSITION AND FLEXIBLE

OVERCOATING MATERIAL COMPRISING THE SAME

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

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CIRCUIT

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Sir:

The Patent Office is requested to provide a corrected Official Filing Receipt for the attached. No fees are required. If you have any questions, please do not hesitate to contact us.

Respectfully submitted,

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CONFIRMATION NO. 9246

FILING RECEIPT

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Date Mailed: 06/05/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Domestic Priority data as claimed by applicant

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THIS APPLICATION IS A 371 OF PCT/JP00/02646 04/21/2000/AAIER & NEUSTADT, P.C.

Foreign Applications

JAPAN 11/115081 04/22/1999

DUCKELING HERM. (1)
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Type of Resp(s):
Due Date(s):

Projected Publication Date: Not Applicable, filed prior to November 29,2000

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Non-Publication Request: No

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Early Publication Request: No

TC 1700

Title

Thermosetting resin composition and flexible circuit overcoating material comprising the same

Preliminary Class

106

PLEASE NOTE THAT THE APPLICANTS' CITIES ARE INCORRECT. THEY SHOULD **READ AS FOLLOWS:**

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